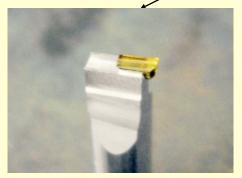
Shapes, materials and principles for vacuum brazing of diamonds

Natural diamond MCD, CVD solid CBN

Cut to raw form

Brazing on shafts, i.e. of hard metal , various sorts of steel also HSS and Kovar copper, molybdenum, Al-bronce 75,

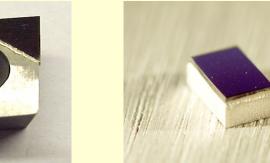
Please note: CVD can only be brazed onto hard metal i.e. K10 or K20 or molybdenum



Ex. MCD on steel shaft



Ex. CVD on hard metal



Ex. CVD on hard metal

Soldering by induction or flame

CVD/CDE

Cut to raw form

Brazing onto hard metal platelets i.e.

K10 ou K20 or molybdenum Size of platelets +0.1mm

Grinding and polishing to final form

Grinding and polishing or electro erosion to final form



Risks of different thermo dilatation properties in composite materials



Allow sufficient space in slits and holes (depending on material, shape or size of the stone + max. 0.01mm)



Diamonds should preferably have neither fractures nor cracks or inclusions

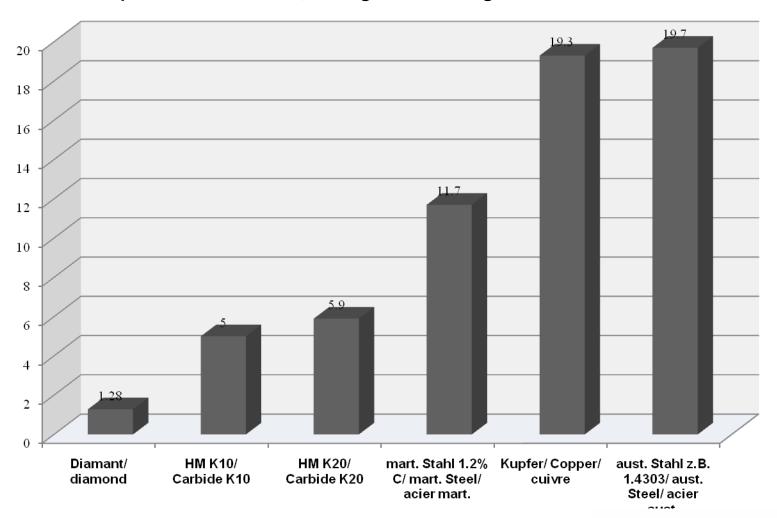


Depending on the size of the stones and the material of the support we use either a more ductile and softer braze or a less ductile but harder braze.



Dangers caused by different thermal expansion coefficients

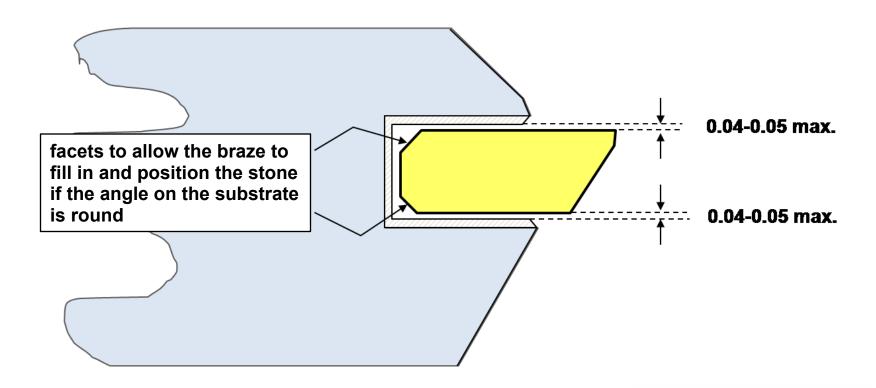
Thermal expansion coefficients, averaged in the range from 0 to 300°C unit 10-6K-1





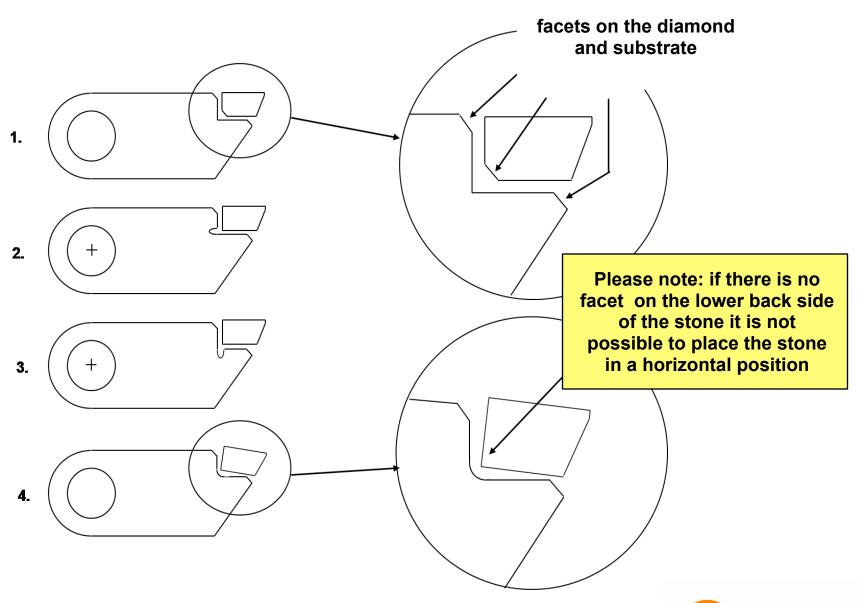
How to shape stones and substrate

- 1. Please make sure the stone will fit into the position you intend and the shape of the stone and the substrate will not inhibit the fit, specially on the back sides
- 2. Allow space between stone and substrate of max. 0.04 0.05 mm on each side



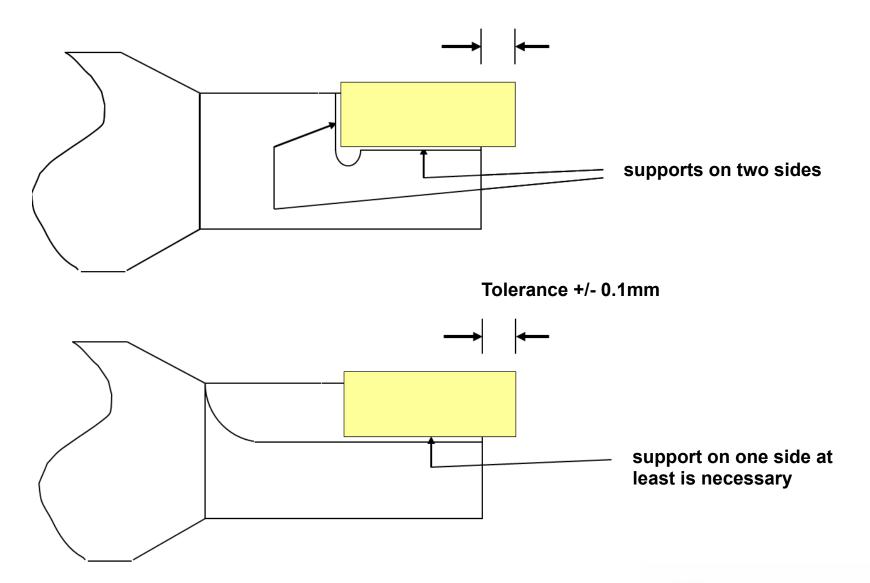


Versions of shapes of diamond and substrate





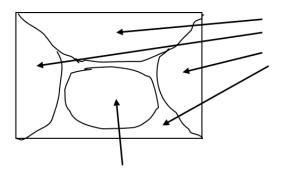
Versions of supporting the stone





Advice for natural diamonds

view from below



facet parallel to the table

natural facets of the diamond

The seat on the bottom may be small but must allow to position the stone parallel to the substrate

L/ H = max. 3.5 for steel e.g. CK and =max. 5 for hard metal substrates

Diamonds with fractures and inclusions are susceptible to total loss by thermal stress when during the cooling process

view from the front side

